MSA1162GT1, MSA1162YT1

General Purpose Amplifier Transistors

PNP Surface Mount

Features

- Moisture Sensitivity Level: 1
- ESD Rating: TBD
- Pb-Free Packages are Available

MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Rating	Symbol	Value	Unit
Collector-Base Voltage	V _{(BR)CBO}	60	Vdc
Collector–Emitter Voltage	V _{(BR)CEO}	50	Vdc
Emitter-Base Voltage	V _{(BR)EBO}	7.0	Vdc
Collector Current – Continuous	Ic	100	mAdc
Collector Current – Peak	I _{C(P)}	200	mAdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Power Dissipation	P_{D}	200	mW
Junction Temperature	TJ	150	°C
Storage Temperature	T _{stg}	-55 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

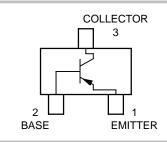
Characteristic	Symbol	Min	Max	Unit
Collector–Emitter Breakdown Voltage (I _C = 2.0 mAdc, I _B = 0)	V _{(BR)CEO}	50	-	Vdc
Collector–Base Breakdown Voltage ($I_C = 10 \mu Adc, I_E = 0$)	V _{(BR)CBO}	60	-	Vdc
Emitter–Base Breakdown Voltage ($I_E = 10 \mu Adc, I_C = 0$)	V _{(BR)EBO}	7.0	-	Vdc
Collector–Base Cutoff Current (V _{CB} = 45 Vdc, I _E = 0)	I _{CBO}	-	0.1	μAdc
	I _{CEO}		0.1 2.0 1.0	μAdc μAdc mAdc
DC Current Gain (Note 1) $(V_{CE} = 6.0 \text{ Vdc}, I_C = 2.0 \text{ mAdc})$ MSA1162YT1 MSA1162GT1	h _{FE}	120 200	240 400	-
Collector–Emitter Saturation Voltage (I _C = 100 mAdc, I _B = 10 mAdc)	V _{CE(sat)}	-	0.5	Vdc
Current-Gain - Bandwidth Product (I _C = 1 mA, V _{CE} = 10.0 V, f = 10 MHz)	f _T	80	_	MHz

^{1.} Pulse Test: Pulse Width $\leq 300~\mu s,~D.C. \leq 2\%.$



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SC-59 CASE 318D STYLE 1

MARKING DIAGRAM



62x = Device Code

x = G or Y

M = Date Code*

= Pb–Free Package

(Note: Microdot may be in either location)
*Date Code orientation may vary depending

upon manufacturing location.

ORDERING INFORMATION

Device*	Package	Shipping [†]
MSA1162GT1	SC-59	3000/Tape & Reel
MSA1162GT1G	SC-59 (Pb-Free)	3000/Tape & Reel
MSA1162YT1	SC-59	3000/Tape & Reel
MSA1162YT1G	SC-59 (Pb-Free)	3000/Tape & Reel

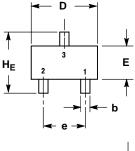
^{*}The "T1" suffix refers to a 7 inch reel.

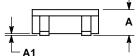
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

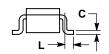
MSA1162GT1, MSA1162YT1

PACKAGE DIMENSIONS

SC-59 CASE 318D-04 ISSUE G







NOTES:

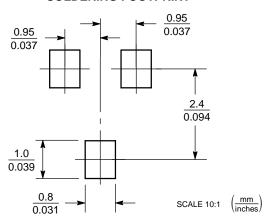
- 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.00	1.15	1.30	0.039	0.045	0.051
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.35	0.43	0.50	0.014	0.017	0.020
С	0.09	0.14	0.18	0.003	0.005	0.007
D	2.70	2.90	3.10	0.106	0.114	0.122
E	1.30	1.50	1.70	0.051	0.059	0.067
е	1.70	1.90	2.10	0.067	0.075	0.083
L	0.20	0.40	0.60	0.008	0.016	0.024
HE	2.50	2.80	3.00	0.099	0.110	0.118

STYLE 1:

- PIN 1. EMITTER
- 2. BASE
- 2. BASE 3. COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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